

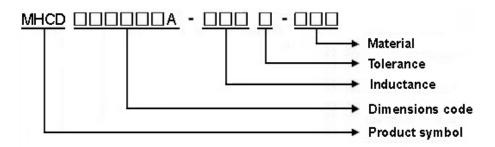
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer :	襲心	
Oustoiner .	一	
Customer P/N:		
Drawing No :		
Quantity:	0 Pcs. Date:	2018/01/12
Chilisin P/N:	MHCD201610A-	R24M-A8L
		_
	SPECIFICATION ACCEPTED BY:	
COMPONENT	7,002,122,211	
ENGINEER		
ELECTRICAL		
ENGINEER		
MECHANICAL		
ENGINEER		
APPROVED		
REJECTED		
奇力新電子股份有限公司 Chilisin Electronics Corp No. 29, Alley 301, Tehhsin Rd., Hukou,Hsinchu 303, Taiwan TEL: +886-3- 599-2646 FAX: +886-3- 599-9176 E-mail: sales@chilisin.com http://www.chilisin.com 奇力新電子(河南)有限公 Chilisin Electronics (Henan) Co XiuWu Xian, industry gathering JiaoZuo, Henan China Postal Code:454350 TEL:+86-391-717-0682 FAX:+86-391-717-0666	Chilisin Electronics (No. 78, Puxing Rd., Qingxi Town, Dongg TEL: +86-769-8773 FAX: +86-769-8773 E-mail: cect@chilisis 新州奇益新電子 SUZHOU QI YIXIN Co.No 179 chang jia	Dongguan) Co., Ltd. Yuliangwei Administration Area, uan City, Guangdong, China -0251~3 3-0232 n.com 阿及公司 Electronics Co., Ltd. ng Road New a
Drawn by 張鈺雯 chang.yuwen	Checked by 張鈺雯 chang.yuwen	Approved by 鍾瑞民 jacky.chung

- 1 Scope: This specification applies to Alloy Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: $-40 \,^{\circ}\text{C} \sim 125 \,^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: $-4~0~{\rm ^{\circ}C} \sim 1~2~5~{\rm ^{\circ}C}$ (after PCB)

4 Marking:

No Marking

5 Standard Testing Condition

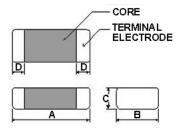
	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°ℂ)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH



ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

MHCD201610A Series Specification

6 Configuration and Dimensions:



Dimensions in mm		
TYPE	MHCD201610A	
Α	2.0±0.2	
В	1.6±0.2	
С	1.0 Max.	
D	0.5±0.3	

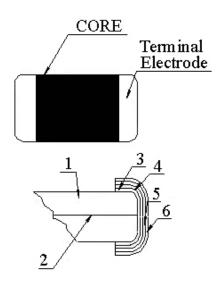
7 Electrical Characteristics:

Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)
MHCD201610A-R24M-A8L	0.24	20	2MHz,0.2V	4.6(5.8)	5.6(7.0)	30(21)

NOTE:

- 1.Operating temperature range $-4~0~{\rm ^{\circ}C} \sim 1~2~5~{\rm ^{\circ}C}$ (Including self temperature rise)
- 2.Isat for Inductance drop 30% from its value without current.
- 3.1rms for a 40 $^{\circ}$ C temperature rise from 25 $^{\circ}$ C ambient.
- 4.All test data is referenced to 25°C ambient
- 5.Absolute maximum voltage 25VDC

8 MHCD201610A Series 8.1 Construction:



8.2 Material List:

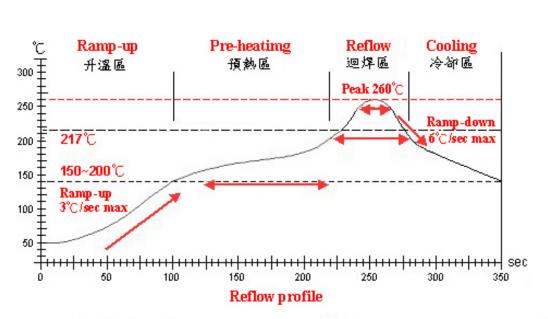
No	Part	Material
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



9 Reliability Of Molding power inductors 1-1.Mechanical Performance

No	ltem	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right	Test device shall be soldered on the substrate
		conditions must not damage	Substrate Dimension: 100x40x1.6mm
		the terminal electrode and the	Deflection: 2.0mm
		metal body	Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for	Test device shall be soldered on the substrate
		microscope of CASTOR MZ-45 20X)	Oscillation Frequency: 10 to 55 to 10Hz for 1min
		Inductance change shall be	Amplitude: 1.5mm
		within ±20%	Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage	Pre-heating: 150℃, 1min
		More than 75% of the terminal.	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		electrode should be covered	Solder Temperature: 260±5°C
		with solder.	Immersion Time: 10±1sec
		Inductance: within ±20% of	
		initial value	
1-1-4	Solder ability	The electrodes shall be at	Pre-heating: 150℃, 1min
	-	least 95% covered with new	Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free)
		solder coating	Solder Temperature: 245±5°C
			Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination	Test device shall be soldered on the substrate,
	· ·	Chip	then apply a force in the direction of the arrow.
			Force : 5N
		F	Keeping Time: 10±1sec
		Mounting Pad	

No	Item	Specification		Test Method	
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:		_
		Inductance:within±20% of	Step	Temperature (°ℂ)	Time (min)
		initial value	1	-40±3	30
			2	25±2	3
			3	125±3	30
			4	25±2	3
			Total: 100d	cycles	
			Measured	after exposure in the room co	ondition for 24hrs
1-2-2 Humidity Resistance			Temperatu	ıre: 60±2°ℂ	
			Relative H	umidity: 90 ~ 95% / Time: 500	Ohrs
			Measured	after exposure in the room co	ondition for 24hrs
1-2-3	High		Temperatu	ıre: 85±3°ℂ	
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs	
			Measured	after exposure in the room co	ondition for 24hrs
1-2-4	Low		Temperatu	ıre: -40±3°ℂ	
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs	
			Measured	after exposure in the room co	ondition for 24hrs



Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	21 7℃	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	_
實際時間 Time result	<u> </u>	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	_

NOTE:

- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow

10 Packaging:

10.1 Packaging -Cover Tape

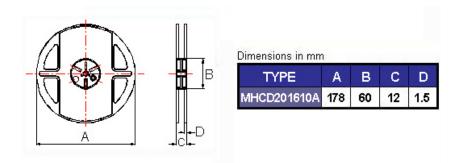
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



10.2 Packaging Quantity

TYPE	PCS/REEL
MHCD201610A	3000

10.3 Reel Dimensions



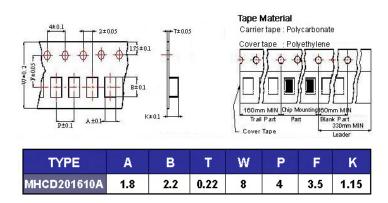


CHILISIN ELECTRONICS CORP.

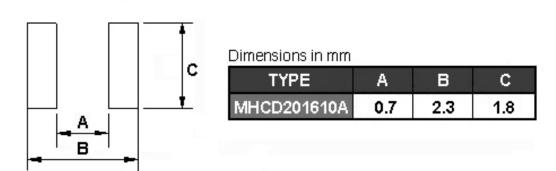
MHCD201610A Series Specification

10 Packaging:

10.4 Tape Dimensions in mm



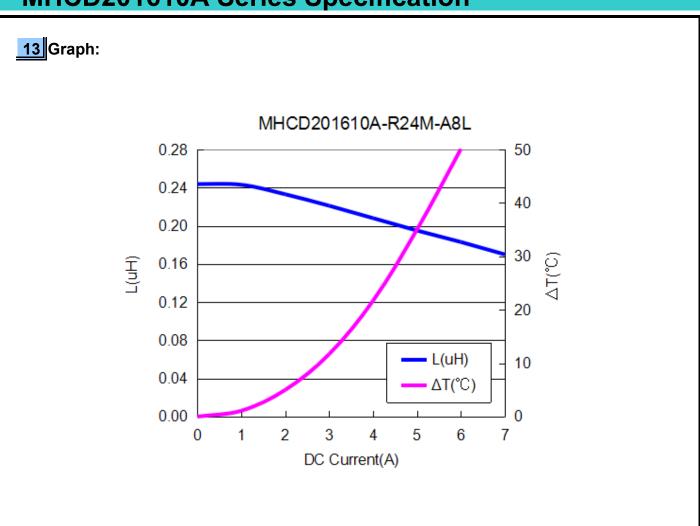
11 Recommended Land Pattern:



12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6.The moisture sensitivity level (MSL) of products is classified as level 1.





单击下面可查看定价,库存,交付和生命周期等信息

>>CHILISIN(奇力新)